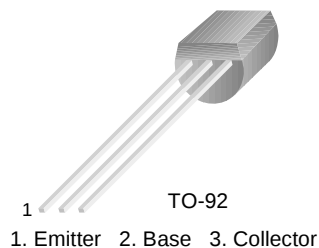


KSP62/63/64

KSP62/63/64

Darlington Transistor

- Collector-Emitter Voltage: V_{CES} =KSP62: 20V
KSP63/64: 30V
- Collector Power Dissipation: P_C (max)=625mW



PNP Epitaxial Silicon Darlington Transistor

Absolute Maximum Ratings $T_a=25^\circ\text{C}$ unless otherwise noted

Symbol	Parameter	Value	Units
V_{CBO}	Collector-Base Voltage		
	: KSP62	-20	V
	: KSP63/64	-30	V
V_{CEO}	Collector-Emitter Voltage		
	: KSP62	-20	V
	: KSP63/64	-30	V
V_{EBO}	Emitter-Base Voltage	-10	V
I_C	Collector Current	-500	mA
P_C	Collector Power Dissipation	625	mW
T_J	Junction Temperature	150	$^\circ\text{C}$
T_{STG}	Storage Temperature	-55~150	$^\circ\text{C}$

Electrical Characteristics $T_a=25^\circ\text{C}$ unless otherwise noted

Symbol	Parameter	Test Condition	Min.	Max.	Units
BV_{CES}	Collector-Emitter Breakdown Voltage	$I_C = -100\mu\text{A}, I_B = 0$			
	: KSP62		-20		V
	: KSP63/64		-30		V
I_{CBO}	Collector Cut-off Current				
	: KSP62	$V_{CB} = -15\text{V}, I_E = 0$		-100	nA
	: KSP63/64	$V_{CB} = -30\text{V}, I_E = 0$		-100	nA
I_{EBO}	Emitter Cut-off Current	$V_{BE} = -10\text{V}, I_C = 0$		-100	nA
h_{FE}	* DC Current Gain				
	: KSP62	$V_{CE} = -5\text{V}, I_C = -10\text{mA}$	20K		
	: KSP63		5K		
	: KSP64		10K		
	: KSP63	$V_{CE} = -5\text{V}, I_C = -100\text{mA}$	10K		
	: KSP64		20K		
$V_{CE(sat)}$	* Collector-Emitter Saturation Voltage				
	: KSP62	$I_C = -10\text{mA}, I_B = -0.01\text{mA}$		-1.0	V
	: KSP63/64	$I_C = -100\text{mA}, I_B = -0.1\text{mA}$		-1.5	V
$V_{BE(on)}$	* Base-Emitter On Voltage				
	: KSP62	$V_{CE} = -5\text{V}, I_C = -10\text{mA}$		-1.4	V
	: KSP63/64	$V_{CE} = -5\text{V}, I_C = -100\text{mA}$		-2	V
f_T	Current Gain Bandwidth Product	$V_{CE} = -5\text{V}, I_C = -100\text{mA}$ $f = 100\text{MHz}$	125		MHz
	: KSP63/64				

* Pulse Test: $PW \leq 300\mu\text{s}$, Duty Cycle $\leq 2\%$

Typical Characteristics

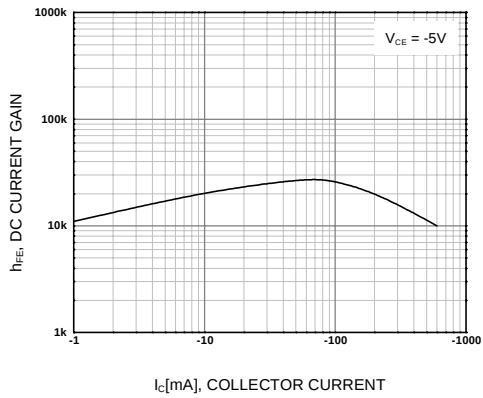


Figure 1. DC current Gain

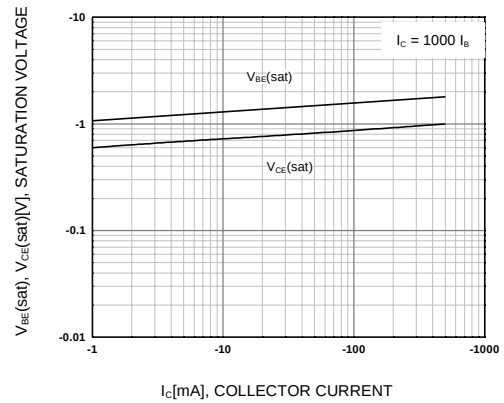


Figure 2. Base-Emitter Saturation Voltage
Collector-Emitter Saturation Voltage

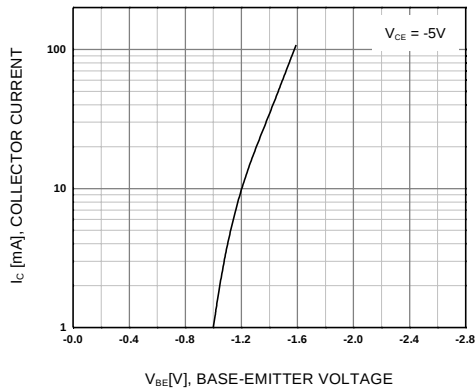


Figure 3. Base-Emitter On Voltage

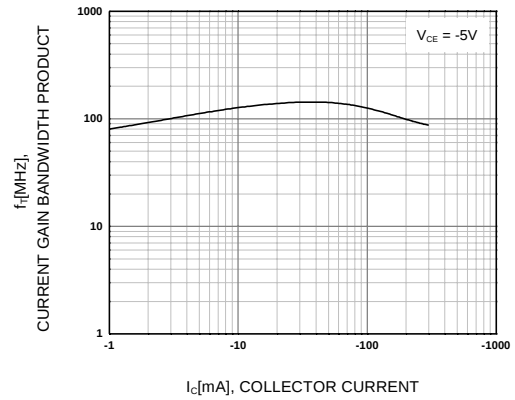


Figure 4. Current Gain Bandwidth Product

Package Dimensions

TO-92



Dimensions in Millimeters

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